

## 2A,50-600V Superfast Rectifiers

### Features

- Low leakage current
- Low forward voltage drop
- Glass passivated chip junction
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260°C/10 seconds



### Applications

For use in secondary rectification and freewheeling for superfast switching speeds of converters in consumer applications.

Maximum Ratings & Electrical Characteristics (T <sub>A</sub> =25°C unless otherwise noted)							
Parameter	Symbol	L2U1	L2U2	L2U3	L2U4	L2U5	Unit
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	2					A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	50					A
Operating junction temperature range	T <sub>J</sub>	-55 to +150					°C
Storage temperature range	T <sub>STG</sub>	-55 to +150					°C

Thermal-Mechanical Specifications (T <sub>A</sub> =25°C unless otherwise noted)			
Parameter	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	85	°C/W
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	15	°C/W
Thermal Resistance, Junction to Lead	R <sub>θJL</sub>	18	°C/W

Electrical Specifications (T <sub>A</sub> =25°C unless otherwise noted)								
Parameter	Symbol	Test Conditions	L2U1	L2U2	L2U3	L2U4	L2U5	Unit
Forward Drop Voltage	V <sub>F</sub>	I <sub>F</sub> =2A	1.0			1.3	1.7	V
Reverse leakage current @V <sub>R</sub>	I <sub>R</sub>	T <sub>J</sub> =25°C	5					uA
		T <sub>J</sub> =125°C	50					
Typical junction capacitance	C <sub>J</sub>	4.0 V 1 MHz	15					pF
Maximum reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>RR</sub> =0.25A	35					nS

Note:

1. Mounted on copper pad area of 0.2x0.2" (5.0 x 5.0mm) to each terminal.

## Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

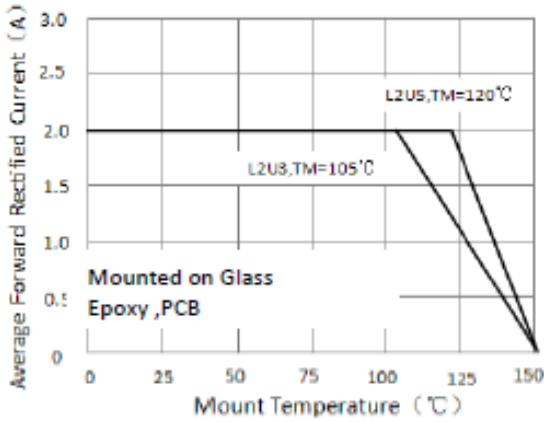


Figure 1. Forward Current Derating Curve

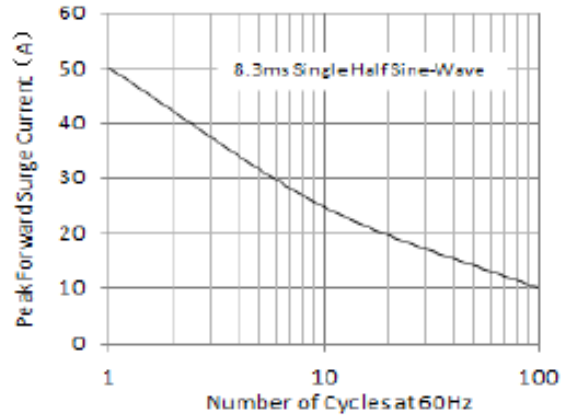


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

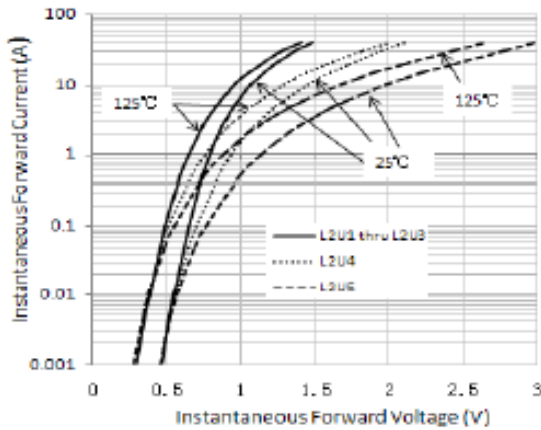


Figure 3. Typical Instantaneous Forward Characteristics

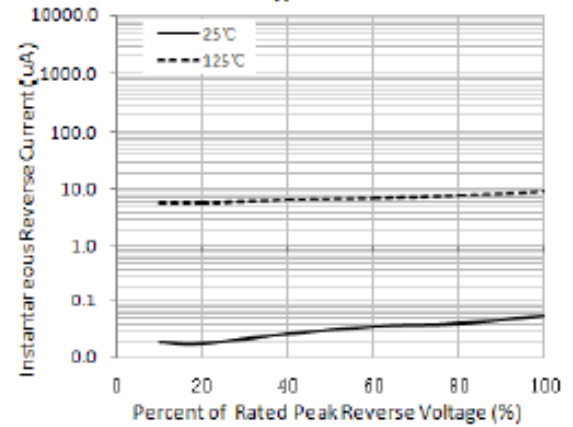
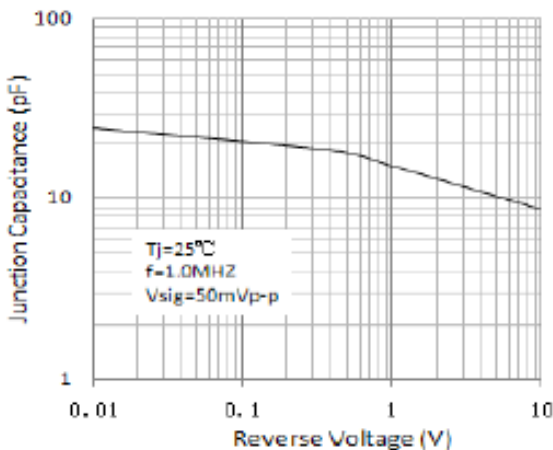


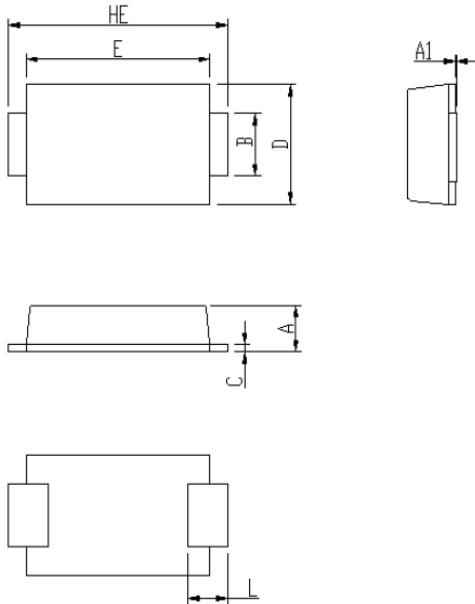
Figure 4. Typical Reverse Characteristics



## Package Outline Dimensions

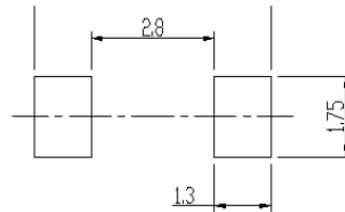
in inches (millimeters)

### eSGB (DO-221AC)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.92	1.08	0.036	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205

Soldering footprint



## Revision History

Document Version	Date of release	Description of changes
Rev.A	2021.06.01	Released Datasheet
Rev.B	2023.10.12	Modify document format
Rev.C	2023.12.29	Modify package name

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